

N7407-VB Datasheet

P-Channel 20-V (D-S) MOSFET

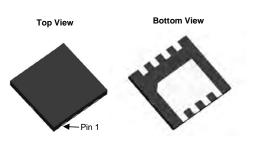
| PRODUCT SUMMARY | | | | | | |
|---------------------|----------------------------------|--------------------|-----------------------|--|--|--|
| V _{DS} (V) | R _{DS(on)} (Ω) | I _D (A) | Q _g (Typ.) | | | |
| - 20 | 0.0040 at V _{GS} = 10 V | - 52 | 21.5 nC | | | |
| - 20 | 0.0060 at V_{GS} = 4.5 V | - 40 | 21.5110 | | | |

FEATURES

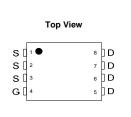
- Halogen-free According to IEC 61249-2-21
 Definition
- Trench Power MOSFET
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC

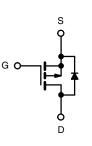
APPLICATIONS

- · Load Switch
- Adaptor/Battery Switch



DFN 3x3 EP





P-Channel MOSFET

| Parameter | | Symbol | Limit | Unit | |
|--|--|-----------------------------------|--|------|--|
| Drain-Source Voltage | | V _{DS} | - 20 | V | |
| Gate-Source Voltage | | V _{GS} | ± 16 | v | |
| Continuous Drain Current (T, = 150 °C) | $T_{C} = 25 \text{ °C}$ $T_{C} = 70 \text{ °C}$ | I _D | - 52 - 40 ^g | | |
| | T _A = 25 °C T _A = 70 °C | | - 26 ^{b, c} - 21 ^{b, c} | A | |
| Pulsed Drain Current | | IDM | - 150 | | |
| Continuous Source-Drain Diode Current | T _C = 25 °C T _A = 25 °C | I _S | - 40 ^g - 4.5 ^{b, c} | _ | |
| | T _C = 25 °C | | 54 | | |
| Maximum Power Dissipation | T _C = 70 °C | PD | 34.7 | w | |
| Maximum Fower Dissipation | T _A = 25 °C | 'D | 5.0 ^{b, c} | VV | |
| | T _A = 70 °C | | 3.2 ^{b, c} | | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 to 150 | °C | |
| Soldering Recommendations (Peak Temperatur | | 260 | - U | | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|---|--------------|-------------------|---------|---------|------|--|
| Parameter | | Symbol | Typical | Maximum | Unit | |
| Maximum Junction-to-Ambient ^{b, f} | t ≤ 10 s | R _{thJA} | 20 | 25 | °C/W | |
| Maximum Junction-to-Case (Drain) | Steady State | R _{thJC} | 1.8 | 2.3 | 0/11 | |

Notes:

a. Based on $T_C = 25 \ ^{\circ}C$.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s.



| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
|---|-------------------------|--|--------|--------|-------|-------|--|
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0, I_{D} = -250 \ \mu A$ | - 20 | | | V | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | I _D = - 250 μA | | - 15 | | mV/°C | |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | i _D = - 250 μA | | 4.5 | | mv/°C | |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$ | - 1 | | - 2.2 | V | |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 16 V$ | | | ± 100 | nA | |
| Zara Cata Valtaga Drain Current | 1 | $V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$ | | | - 1 | ۸ | |
| Zero Gate Voltage Drain Current | IDSS | V_{DS} = - 20 V, V_{GS} = 0 V, T_{J} = 55 °C | | | - 10 | μA | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \le$ - 5 V, V_{GS} = - 10 V | - 30 | | | А | |
| | Б | V _{GS} = - 10 V, I _D = - 26 A | 0.0040 | | | Ω | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = - 4.5 V, I _D = - 21 A | | 0.0060 | | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = - 10 V, I _D = - 26 A | | 58 | | S | |
| Dynamic ^b | | | | | | | |
| Input Capacitance | C _{iss} | | | 4595 | | pF | |
| Output Capacitance | C _{oss} | V _{DS} = - 10 V, V _{GS} = 0 V, f = 1 MHz | | 910 | | | |
| Reverse Transfer Capacitance | C _{rss} | | | 813 | | | |
| Total Gate Charge | Qg | V_{DS} = - 10 V, V_{GS} = - 10 V, I_D = - 20 A | | 95.3 | 143 | | |
| | | | | 46.5 | 70 | | |
| Gate-Source Charge | Q _{gs} | V_{DS} = - 10 V, V_{GS} = - 4.5 V, I_{D} = - 20 A | | 13.7 | | | |
| Gate-Drain Charge | Q _{gd} | | | 12.5 | | | |
| Gate Resistance | Rg | f = 1 MHz | 0.4 | 1.9 | 3.8 | Ω | |
| Turn-On Delay Time | t _{d(on)} | | | 19 | 30 | | |
| Rise Time | t _r | V_{DD} = - 10 V, R _L = 1 Ω | | 10 | 20 |] | |
| Turn-Off Delay Time | t _{d(off)} | $I_{D}\cong$ - 10 A, V_{GEN} = - 10 V, R_{g} = 1 Ω | | 65 | 98 |] | |
| Fall Time | t _f | | | 13 | 20 | nc | |
| Turn-On Delay Time | t _{d(on)} | | | 55 | 83 | - ns | |
| Rise Time | t _r | V_{DD} = - 10 V, R_L = 1 Ω | | 52 | 78 | | |
| Turn-Off Delay Time | t _{d(off)} | $\text{I}_{\text{D}}\cong$ - 10 A, V_{GEN} = - 4.5 V, R_{g} = 1 Ω | | 53 | 80 | | |
| Fall Time | t _f | | | 25 | 38 | | |
| Drain-Source Body Diode Characteris | tics | | | | | | |
| Continuous Source-Drain Diode Current | ا _S | T _C = 25 °C | | | - 40 | A | |
| Pulse Diode Forward Current ^a | I _{SM} | | | | - 70 | | |
| Body Diode Voltage | V _{SD} | I _S = - 1 A | | - 0.74 | - 1.1 | V | |
| Body Diode Reverse Recovery Time | t _{rr} | | | 42 | 63 | ns | |
| ody Diode Reverse Recovery Charge Q _{rr} | | I _F = - 10 A, dl/dt = 100 A/μs, T _J = 25 °C | | 25 | 38 | nC | |
| Reverse Recovery Fall Time | t _a | $-1_{\rm F} = -10$ A, u/ul = 100 A/µs, $1_{\rm J} = 25$ °C - | | 12 | | ns | |
| Reverse Recovery Rise Time | t _b | l | | 30 | | 115 | |

Notes:

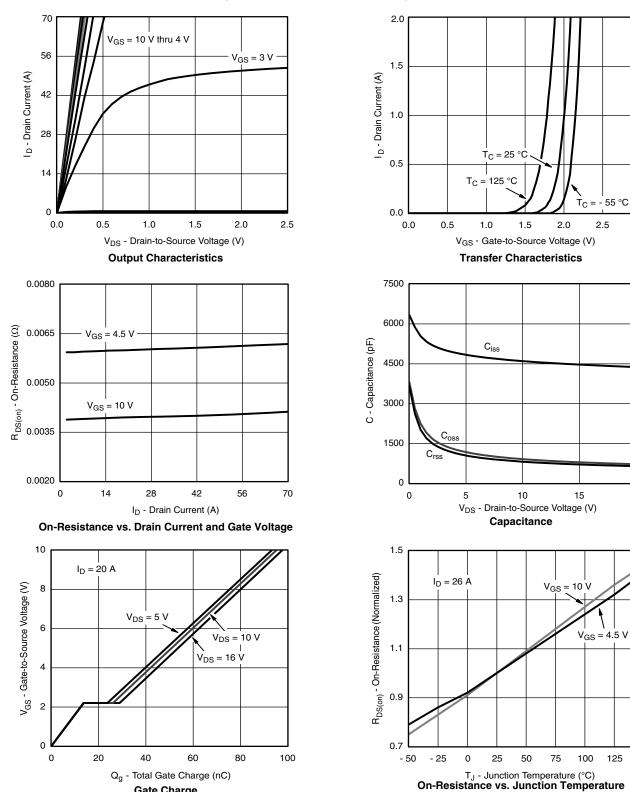
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



3.0

20

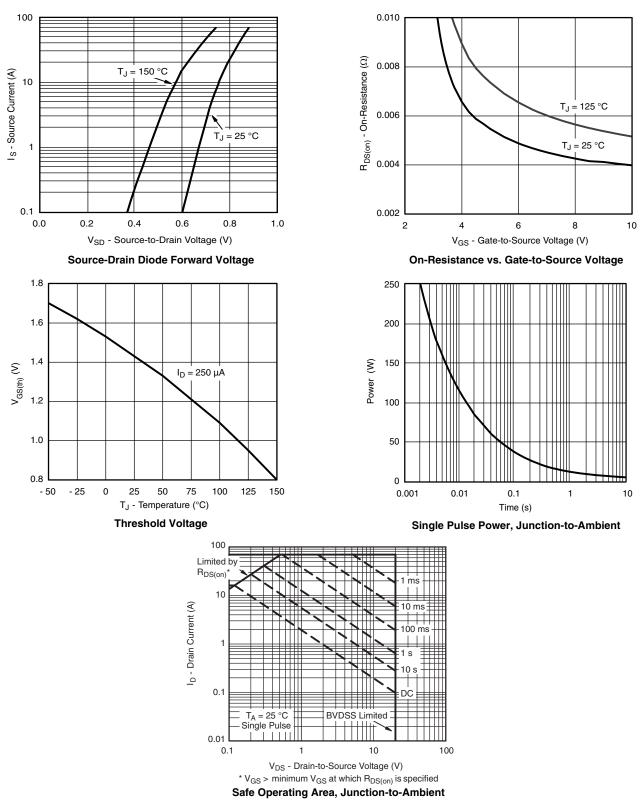


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Gate Charge

150

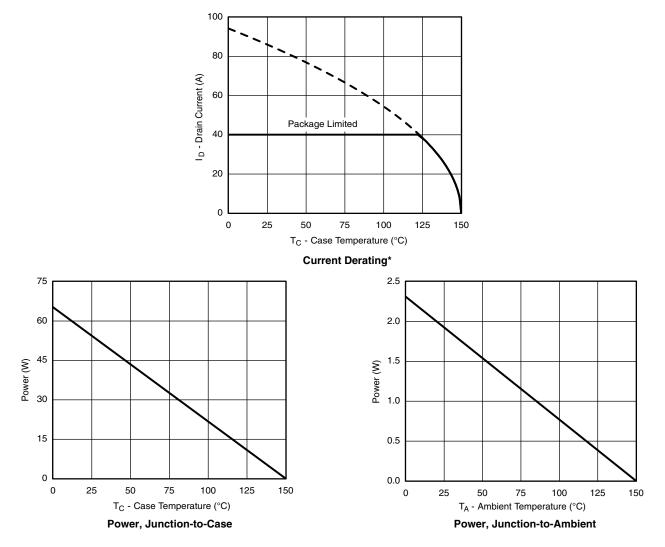




TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



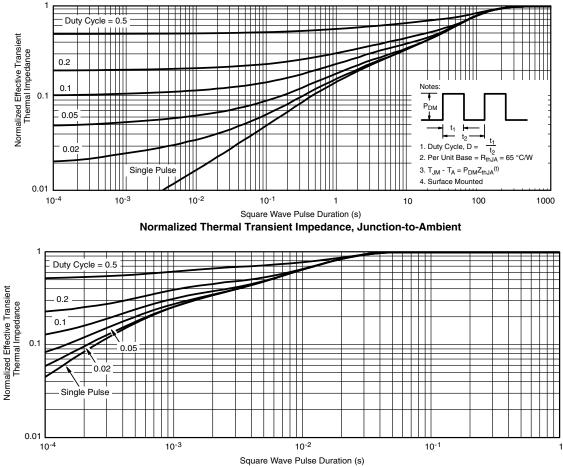
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

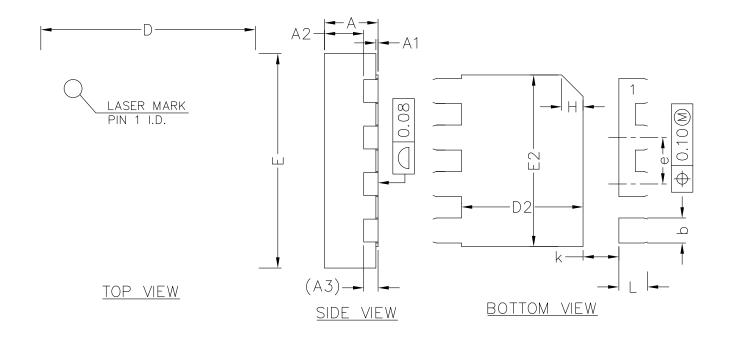


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case







<u>SIDE VIEW</u>

| | | r | | |
|--------|---------|------|------|--|
| SYMBOL | MIN | NOM | MAX | |
| А | 0.70 | 0.75 | 0.80 | |
| A1 | 0.00 | 0.02 | 0.05 | |
| A2 | 0.50 | 0.55 | 0.60 | |
| A3 | 0.20REF | | | |
| b | 0.30 | 0.35 | 0.40 | |
| D | 2.90 | 3.00 | 3.10 | |
| E | 2.90 | 3.00 | 3.10 | |
| D2 | 1.60 | 1.70 | 1.80 | |
| E2 | 2.30 | 2.40 | 2.50 | |
| е | 0.55 | 0.65 | 0.75 | |
| K | 0.40 | 0.50 | 0.60 | |
| | 0.35 | 0.40 | 0.45 | |

COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)



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